

LINEAR TECHNOLOGY MATERIALS DECLARATION

|                                   |                                  |                           |            |                      |                               |                                 |
|-----------------------------------|----------------------------------|---------------------------|------------|----------------------|-------------------------------|---------------------------------|
| 1t6235ign#trpbf                   |                                  | (Engineering Calculation) |            |                      |                               | SSOP                            |
| (printed on: 2020-07-11 18:37:55) |                                  |                           |            |                      | TOTAL MASS (g) :              | 0.079989                        |
| COMPONENT MATERIAL                | VENDOR/ INDUSTRY NAMES           | CONSTITUENT NAME          | CAS NUMBER | CONSTITUENT MASS (g) | CONSTITUENT (PPM) OF MATERIAL | CONSTITUENT (PPM) OF TOTAL PKG. |
| Active Device                     | Linear Technology                | Silicon (Si)              | 7440-21-3  | 0.001488             | 1000000                       | 18602.5410156                   |
| Die Coat                          | Dow Corning                      | Silicone                  | 69430-27-9 | 0.000062             | 1000000                       | 775.105834961                   |
| Lead Frame                        | Cu                               | Copper (Cu)               | 7440-50-8  | 0.029933             | 975000                        | 374213.59375                    |
|                                   |                                  | Iron (Fe)                 | 7439-89-6  | 0.000737             | 24000                         | 9213.75878906                   |
|                                   |                                  | Phosphorus (P)            | 7723-14-0  | 0.000009             | 300                           | 112.515365601                   |
|                                   |                                  | Zinc (Zn)                 | 7440-66-6  | 0.000021             | 700                           | 262.535858154                   |
|                                   |                                  | Nickel (Ni)               | 7440-02-0  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Silicon (Si)              | 7440-21-3  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Magnesium (Mg)            | 7439-95-4  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Tin (Sn)                  | 7440-31-5  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Lead Frame Total:         |            | 0.030700             | 1000000                       | 383802.40625                    |
| Plating                           | PMI                              | Exter. Plating Pb         | 7439-92-1  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Exter. Plating Sn         | 7440-31-5  | 0.002272             | 1000000                       | 28404.8808594                   |
|                                   |                                  | External Plating Total:   |            | 0.002272             | 1000000                       | 28404.8808594                   |
|                                   |                                  | Inter. Plating Ni         | 7440-02-0  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Inter. Plating Ag         | 7440-22-4  | 0.000246             | 1000000                       | 3075.42016602                   |
|                                   |                                  | Internal Plating Total:   |            | 0.000246             | 1000000                       | 3075.42016602                   |
| Die Attach                        | ELECTRICALLY CONDUCTIVE ADHESIVE | Silver (Ag)               | 7440-22-4  | 0.000565             | 750000                        | 7063.46435547                   |
|                                   |                                  | Tin (Sn)                  | 7440-31-5  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Lead (Pb)                 | 7439-92-1  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Silica (SiO2)             | 60676-86-0 | 0.000000             | 0                             | 0                               |
|                                   |                                  | Indium (In)               | 7440-74-6  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Metal Oxide               |            | 0.000000             | 0                             | 0                               |
|                                   |                                  | Antimony (Sb)             | 7440-36-0  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Resin (EP)                |            | 0.000188             | 250000                        | 2350.32104492                   |
|                                   |                                  | Die Attach Total:         |            | 0.000753             | 1000000                       | 9413.78515625                   |
| Encapsulation                     | MULTI-AROMATIC RESIN Br/Sb FREE  | Resin (EP)                |            | 0.006605             | 150000                        | 82573.7734375                   |
|                                   |                                  | Bromine (Br)              | 40039-93-8 | 0.000000             | 0                             | 0                               |
|                                   |                                  | Silica (SiO2)             | 60676-86-0 | 0.036105             | 820000                        | 451374.15625                    |
|                                   |                                  | Antimony Trioxide (Sb2O3) | 1309-64-4  | 0.000000             | 0                             | 0                               |
|                                   |                                  | Metal Hydroxide           |            | 0.001101             | 25000                         | 13764.3798828                   |
|                                   |                                  | Carbon Black (C)          | 1333-86-4  | 0.000220             | 5000                          | 2750.37548828                   |
|                                   |                                  | Encapsulation Total:      |            | 0.044031             | 1000000                       | 550462.6875                     |
| Bond Wire Estimated               | AFW/TANAKA/ Kn                   | Gold (Au)                 | 7440-57-5  | 0.000437             | 1000000                       | 5463.24609375                   |
|                                   |                                  |                           |            |                      | TOTAL MASS (g) :              | 0.079989                        |